

L Number	Hits	Search Text	DB	Time stamp
4	495	(polish\$3 adj pad) same window	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 17:52
5	5	(planar\$3 adj pad) same window	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 17:53
6	48	(polish\$3 adj pad) same window same (notch or groove)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 17:53
16	0	conductive adj planarizing adj pad	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 18:22
15	27	conductive adj polishing adj pad	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/30 18:28